

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Operating Temperature Range

-25° to 70° C, relative humidity of 85% or less

Materials

- 1. Tip contact: C5191, 40μ" Ni plated, 1 μ" Au plated 2. Ring contact: C5191, 40μ" Ni plated, 1 μ" Au plated 3. Ring contact: C5191, 40μ" Ni plated, 1 μ" Au plated 4. Sleeve contact: C5191, 40μ" Ni plated, 1 μ" Au plated
- 5. Shell: C2700 brass, 1 µm nickel plated
- 6. Top head: C3603 brass, 1 µm nickel plated
- 7. Insulator: PBT (UL94-HB), black

Electrical Requirements

Dielectric strength: 1 min @ 200 Vac Insulation resistance: 50 MΩ @ 100 Vdc Contact resistance: $100 \text{ m}\Omega$ or less

Mechanical Requirements

Insertion force: 0.4-4 kgf Withdrawal force: 0.4-4 kgf

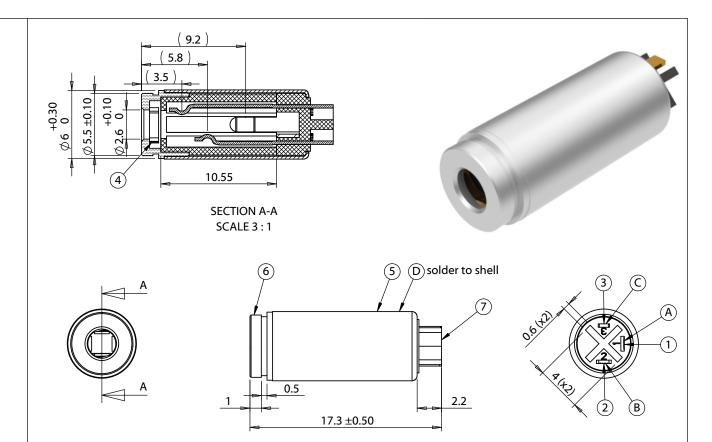
Life cycle: 5000 mating cycles while maintaining 0.3 kgf min. insertion force, 0.3 kgf min. withdrawal force and less than 100 m Ω contact resistance.

Environmental Requirements

Heat test: 70 °C, relative humidity 70-85% for 96 hours without deformation

Humidity test: 40 °C, relative humidity 90-100% for 96 hours without deformation

Salt spray test: 35±2 °C, relative humidity 90-95%, 5% NaCl mist for 24 hrs. Wash parts after test. Maintain mechanical requirements and a contact resistance of less than 100 m Ω .



Schematic

